- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- 3-State Outputs Drive Bus Lines or Buffer-Memory Address Registers
- ESD Protection Exceeds 2000 V Per MIL-STD-883 Method 3015
- High-Impedance State During Power Up and Power Down
- Package Options Include Plastic Small-Outline (D) and Standard Plastic 300-mil DIPs (N)

(TOP VIEW) 14 🛮 V_{CC} 10E [] 1A 🛛 13 40E 2 1Y [] 3 12 **∏** 4A 20E [0 4Y 11 10 30E 2A 🛮 5 2Y [] 6 9 🛮 3A GND [8 3Y

D OR N PACKAGE

description

The SN64BCT126A bus buffer features independent line drivers with 3-state outputs. Each output is disabled when the associated output-enable (OE) input is low.

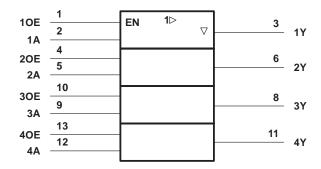
The SN64BCT126A is characterized for operation from – 40°C to 85°C and 0°C to 70°C.

FUNCTION TABLE (each buffer)

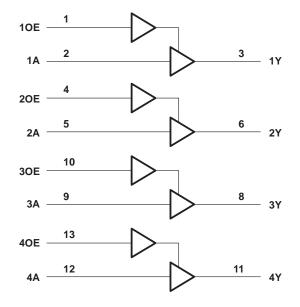
INPUTS		OUTPUT
OE	Α	Y
Н	Н	Н
Н	L	L
L	Χ	Z

logic symbol†

logic diagram (positive logic)



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

1

SN64BCT126A QUADRUPLE BUS BUFFER GATE WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	. -0.5 V to 7 V
Input voltage range, V _I (see Note 1)	. -0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, V _O	-0.5 V to 5.5 V
Voltage range applied to any output in the high state, V _O	-0.5 V to V _{CC}
Current into any output in the low state, I _O	128 mA
Package thermal impedance, θ _{JA} (see Note 2): D package	127°C/W
N package	78°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative voltage rating may be exceeded if the input clamp current rating is observed.
 - 2. The package thermal impedance is calculated in acordane with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 3)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			8.0	V
lικ	Input clamp current			-18	mA
ЮН	High-level output current			-15	mA
loL	Low-level output current			64	mA
TA	Operating free-air temperature	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TES	MIN	TYP [†]	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
Vari	Voc - 45 V	I _{OH} = -3 mA	2.4	3.3		V
VOH	V _{CC} = 4.5 V	I _{OH} = -15 mA	2	3.1		v
V _{OL}	$V_{CC} = 4.5 V,$	I _{OH} = 64 mA		0.42	0.55	V
lozh	V _{CC} = 5.5 V,	$V_0 = 2.7 \text{ V}$			50	μΑ
lozL	V _{CC} = 5.5 V,	$V_0 = 0.5 V$			-50	μΑ
lo-	V _{CC} = 0 to 1.3 V (power up)	V _O = 2.7 V or 0.5 V, OE at 2 V			±50	
loz	$V_{CC} = 1.3 \text{ V to 0 (power down)}$	$V_0 = 2.7 \text{ V or } 0.5 \text{ V},$ OE at 2 V			±50	μΑ
lį	$V_{CC} = 0$,	V _I = 7 V			0.1	mA
lН	V _{CC} = 5.5 V,	V _I = 2.7 V			25	μΑ
Ι _{ΙL}	V _{CC} = 5.5 V,	V _I = 0.5 V			-20	μΑ
los [‡]	V _{CC} = 5.5 V,	V _O = 0	-100		-225	mA
ICCL	V _{CC} = 5.5 V			35	51	mA
ICCH	V _{CC} = 5.5 V			21	33	mA
Iccz	V _{CC} = 5.5 V			5	10	mA
C _i	V _{CC} = 5 V,	V _I = 2.5 V or 0.5 V		4		pF
Co	V _{CC} = 5 V,	V _O = 2.5 V or 0.5 V		9		pF

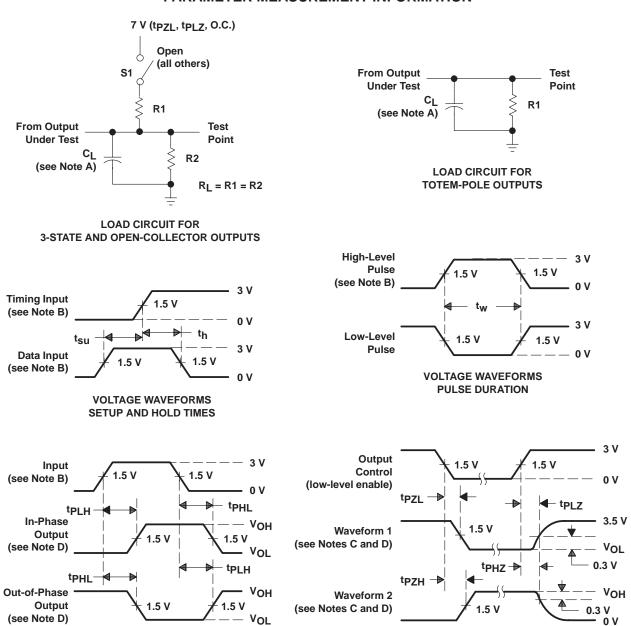
 $[\]uparrow$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics (see Figure 1)

PARAMETER	FROM	TO	$\begin{array}{c} \text{V}_{\text{CC}} = 5 \text{ V}, \\ \text{C}_{\text{L}} = 50 \text{ pF}, \\ \text{TO} \\ \text{(OUTPUT)} \\ \text{R2} = 500 \ \Omega, \\ \text{T}_{\text{A}} = 25^{\circ}\text{C} \end{array}$		V_{CC} = 4.5 V to 5.5 V C_L = 50 pF, R1 = 500 Ω , R2 = 500 Ω				UNIT		
	(INPUT)	(001P01)			T _A = -40 °C to 85 °C		T _A = 0°C to 70°C				
			MIN	TYP	MAX	MIN	MAX	MIN	MAX		
t _{PLH}	А	Y	1.5	3.6	4.9	1.5	6.3	1.5	6.3	ns	
t _{PHL}		٨	'	2.7	5.3	6.9	2.7	7.7	2.7	7.4	115
^t PZH	OE	Y	2.6	4.8	6.4	2.6	7.9	2.6	7.9	ns	
t _{PZL}		'	3.7	6.4	8.3	3.7	10.5	3.7	10	115	
^t PHZ	OE	OE \	Y	3.2	6.6	8.2	3.2	10	3.2	10	ns
t _{PLZ}		'	3.4	6.5	8	3.4	12.3	3.4	10.7	115	

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

VOLTAGE WAVEFORMS

PROPAGATION DELAY TIMES (see Note D)

B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $t_{\Gamma} = t_{\Gamma} \leq$ 2.5 ns, duty cycle = 50%.

VOLTAGE WAVEFORMS

ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.
- E. When measuring propagation delay times of 3-state outputs, switch S1 is open.

Figure 1. Load Circuits and Voltage Waveforms



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